

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: KIM, Sangyum; CHOI, Chang Hee; JO, Cha Jae; KIM, Jeong Ik; WOO, Kyung
Nyung; KI, Joon Seo; MOON, Hong Gi

SERIAL NO.:

FILED: Herewith

TITLE: METHOD FOR MANUFACTURING VERY LOW ROUGHNESS
ELECTRODEPOSITED COPPER FOIL AND ELECTRODEPOSITED COPPER FOIL
MANUFACTURED THEREBY

REMARKS ON PRELIMINARY AMENDMENT

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450
Sir:

In this preliminary amendment, please consider the following remarks in conjunction with
the amendments to the above-identified application as follows:

REMARKS

The present Preliminary Amendment has been entered for the purpose of placing the
application into a more proper U.S. format. In particular, certain grammatical and idiomatic
inconsistencies have been corrected by amendment to the specification, and the application is
corrected for certain formalities in the originally submitted application. The present application is
an English translation of an originally Korean language document. No new matter has been added
by these amendments.

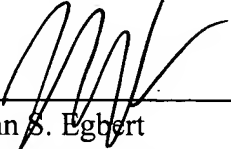
The Claims have been amended so as to conform with U. S. formalities.

Applicant respectfully requests that the present Amendment be entered prior to an initial
Official Action on the present application.

Respectfully submitted,

Date

11-21-03



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